

MB1-130-01-F-S-01-SL-N



(1,00 mm) .0394" MB1 SERIES

MINI EDGE CARD SOCKET WITH GUIDES

Mates with:

(0,80 mm) .031" PCB, (1,60 mm) .062" PCB

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MB1

Insulator Material: Black LCP

Contact Material:

Plating: Sn or Au over 50µ" (1,27 µm) Ni Operating Temp Range: -55°C to +125°C

-55°C to +125°C Insertion Depth: (5,26 mm) .207" to (6,10 mm) .240" RoHS Compliant: Yes

Processing: Lead-Free Solderable:

Yes____

SMT Lead Coplanarity: (0,10 mm) .004" max (20-30) (0,15 mm) .006" max (40-50)

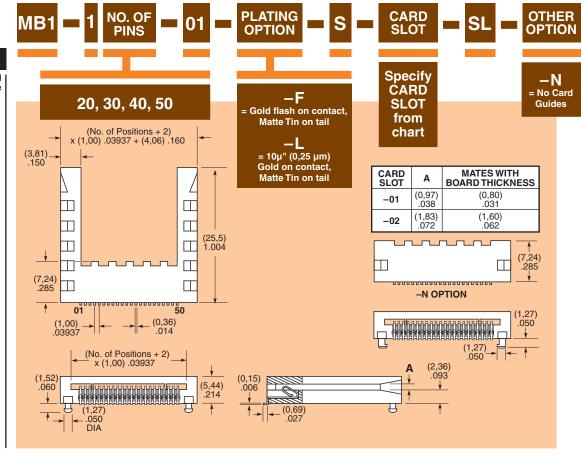
Important Note:

Samtec recommends that pads on the mating board be Gold plated.

Note: Other Gold plating options available. Contact Samtec.

Note

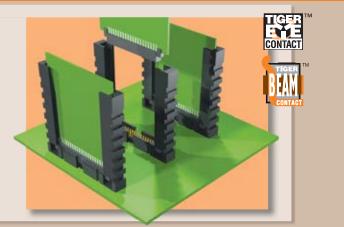
Some sizes, styles and options are non-standard, non-returnable.



ALSO AVAILABLE

Flex Card System

- .050" (1,27 mm) (FCF/EMF Series) systems
- · Vertical and horizontal
- · Header with snap-on card guides for design flexibility
- · Elevated design now available
- PCMCIA (PCMT/PCMS Series) Compact Flash (CFT/CFS Series) compatible applications available
- · Ideal for multiple add-on cards
- · Solder locks for mechanical stability
- · Any size from 40 to 100 contacts



Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM